

# Low Voltage, 5Ω, 4-Channel 2-Port *NanoSwitch*™

#### **Features**

- · Near-Zero propagation delay
- $5\Omega$  switches connect inputs to outputs
- High signal passing bandwidth (500 MHz)
- · Beyond Rail-to-Rail switching
- 5V I/O tolerant with 3.3V supply in OFF and ON state
- 2.5V and 3.3V supply voltage operation
- · Hot insertion capable
- Industrial operating temperature: -40°C to +85°C
- 2kV ESD protection (human body model)
- Latch-up performance: >250mA per JESD17
- Packaging (Pb-free & Green available):
  - 16-pin TSSOP (L)
  - 16-pin QSOP (Q)

### **Description**

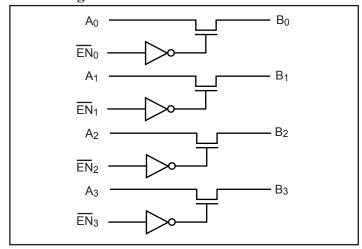
The PI3CH400 is a low voltage, 4-channel switch designed with fast indiviual enables. The switch introduces no additional propagation delay or additional ground bounce noise.

The PI3CH400 device has active LOW enables. It is very useful in switching signals that have high bandwidth (500 MHz).

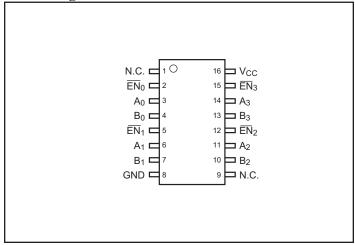
### **Applications**

- · High Bandwidth Data Switching
- · Hot-Docking
- · Analog Signal Switching
- · Differential Signal Switching

# **Block Diagram**



# **Pin Configuration**



#### **Notes:**

1. N.C. = No internal connection

# Truth Table<sup>(1)</sup>

ENx	Ax	Bx	V <sub>CC</sub>	Function
$X^{(2)}$	Hi-Z	Hi-Z	GND	Disconnect
Н	Hi-Z	Hi-Z	V <sub>CC</sub>	Disconnect
L	Bx	Ax	V <sub>CC</sub>	Connect

#### **Notes:**

- H = High Voltage Level
   L = Low Voltage Level
   Hi-Z = High-Impedance
- 2. A pull-up resistor should be provided for power-up protection.

### **Pin Description**

Pin Name	Description
$\overline{\mathrm{EN}}_{\mathrm{x}}$	Switch Enable
A <sub>3</sub> - A <sub>0</sub>	A Ports
B <sub>3</sub> - B <sub>0</sub>	B Ports
GND	Ground
V <sub>CC</sub>	Power



### **Maximum Ratings**

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature65°C to +150°C
Ambient Temperature with Power Applied40°C to +85°C
Supply Voltage to Ground Potential0.5V to +4.6V
DC Input Voltage0.5V to +6.0V
DC Output Current
Power Dissipation

#### Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

# **DC Electrical Characteristics, 3.3V Supply** (Over Operating Range, $T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$ , $V_{CC} = 3.3\text{V} \pm 10\%$ )

Parameters	Description	Test Conditions <sup>(1)</sup>	Min.	Typ.(2)	Max.	Units
V <sub>IH</sub>	Input HIGH Voltage	Guaranteed Logic HIGH Level	2			
$V_{\mathrm{IL}}$	Input LOW Voltage	Guaranteed Logic LOW Level	-0.5		0.8	V
V <sub>IK</sub>	Clamp Diode Voltage	$V_{CC} = Min., I_{IN} = -18mA$		-1.3	-1.8	
I <sub>IH</sub>	Input HIGH Current	$V_{CC} = Max., V_{IN} = V_{CC}$			±1	
$I_{ m IL}$	Input LOW Current	$V_{CC} = Max., V_{IN} = GND$			±1	μΑ
I <sub>OZH</sub>	High-Impedence Current	$0 \le A, B \le V_{CC}$			±1	
R <sub>ON</sub>	Switch On-Resistance <sup>(3)</sup>	$V_{CC} = Min., V_{IN} = 0V$ $I_{ON} = -48mA \text{ or } -64mA$		4	6	Ω
		$V_{CC} = Min., V_{IN} = 3.6V, I_{ON} = -15mA$		5	8	

#### **Notes:**

- 1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at  $V_{CC} = 3.3V$ ,  $T_A = 25^{\circ}C$  ambient and maximum loading.
- 3. Measured by the voltage drop between A and B pin at indicated current through the switch. On-Resistance is determined by the lower of the voltages on the two (A,B) pins.



## **DC Electrical Characteristics, 2.5V Supply** (Over Operating Range, $T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$ , $V_{CC} = 2.5\text{V} \pm 10\%$ )

Parameters <sup>(4)</sup>	Description	Test Conditions <sup>(1)</sup>	Min.	Typ.(2)	Max.	Units
$V_{ m IH}$	Input HIGH Voltage	Guaranteed Logic HIGH Level	1.8		$V_{CC} + 0.3$	
$V_{ m IL}$	Inout LOW Voltage	Guaranteed Logic LOW Level	-0.3		0.8	V
V <sub>IK</sub>	Clamp Diode Voltage	$V_{CC} = Max., I_{IN} = -6mA$		-0.7	-1.8	
$I_{\mathrm{IH}}$	Input HIGH Current	$V_{CC} = Max., V_{IN} = V_{CC}$			±1	
$I_{\mathrm{IL}}$	Input LOW Current	$V_{CC} = Max., V_{IN} = GND$			±1	μΑ
I <sub>OZH</sub>	High Impedance Current	$0 \le A, B \le V_{CC}$			±1	
Day	Switch On-Resistance <sup>(3)</sup>	$V_{CC} = Min., V_{IN} = 0V,$ $I_{ON} = -48mA$		4	8	Ω
R <sub>ON</sub>	Switch On-Resistance	$V_{CC} = Min., V_{IN} = 2.25V,$ $I_{ON} = -15mA$		7	14	5.2

#### **Notes:**

- 1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at  $V_{CC} = 3.3V$ ,  $T_A = 25^{\circ}C$  ambient and maximum loading.
- 3. Measured by the voltage drop between A and B pin at indicated current through the switch. On-Resistance is determined by the lower of the voltages on the two (A,B) pins.
- 4. This parameter is determined by device characterization but is not production tested.

### Capacitance ( $T_A = 25^{\circ}C f = 1 \text{ MHz}$ )

Parameters <sup>(1)</sup>	Description	Test Conditions	Тур.	Units
$C_{IN}$	Input Capacitance		1.8	
$C_{OFF}$	A/B Capacitance, Switch Off	$V_{IN} = 0V$	3.0	pF
C <sub>ON</sub>	A/B Capacitance, Switch On		6.4	

#### **Notes:**

1. This parameter is determined by device characterization but is not production tested.

# **Power Supply Characteristics**

Parameters	Description	Test Conditions <sup>(1)</sup>	Min.	Typ.(2)	Max.	Units
$I_{CC}$	Quiescent Power Supply Current	$V_{CC} = 3.6V$ , $V_{IN} = GND$ or $V_{CC}$			0.8	mA

#### **Notes:**

- 1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
- 2. Typical values are at  $V_{CC} = 3.3V$ , +25°C ambient.



# **Dynamic Electrical Characteristics Over the Operating Range** ( $T_A = -40^{\circ}$ to $+85^{\circ}$ , $V_{CC} = 3.3 \text{V} \pm 10\%$ )

Parameter	Description	<b>Test Condition</b>	Min.	Тур.	Max.	Units
X <sub>TALK</sub>	Crosstalk	10 MHz		-60		σĿ
$O_{IRR}$	Off-Isolation	10 MHz		-60		dB
BW	-3dB Bandwidth	See Test Diagram	200	500		MHz

# Switching Characteristics over 3.3V Operating Range

Parameters	Description	Conditions <sup>(1)</sup>		Com.		Units
rarameters	Description	Conditions	Min.	Тур.	Max.	Units
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay <sup>(2,3)</sup> Ax to Bx, Bx to Ax	See Test Diagram			0.3	
t <sub>PZH</sub> t <sub>PZL</sub>	Enable Time $\overline{EN}x$ to $Ax$ or $Bx$	Can Tost Dingram	1.5		9.0	ns
$t_{ m PHZ} \ t_{ m PLZ}$	Disable Time $\overline{EN}x$ to $Ax$ or $Bx$	See Test Diagram	1.5		9.0	

#### **Notes:**

- 1. See test circuit and waveforms.
- 2. This parameter is guaranteed but not tested on Propagation Delays.
- 3. The switch contributes no propagational delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25ns for 10pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagational delay to the system. Propagational delay of the switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

### Switching Characteristics over 2.5V Operating Range

Danamatana	Description	Conditions <sup>(1)</sup>	Com.		IIn:ta
Parameters	Description	Conditions	Min.	Max.	Units
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay <sup>(2,3)</sup> Ax to Bx, Bx to Ax	See Test Diagram		0.3	
t <sub>PZH</sub> t <sub>PZL</sub>	Enable Time $\overline{\mathrm{EN}}\mathrm{x}$ to $\mathrm{Ax}$ or $\mathrm{Bx}$	San Tagt Diagram	1.5	15.0	ns
t <sub>PHZ</sub>	Disable Time ENx to Ax or Bx	See Test Diagram	1.5	12.0	

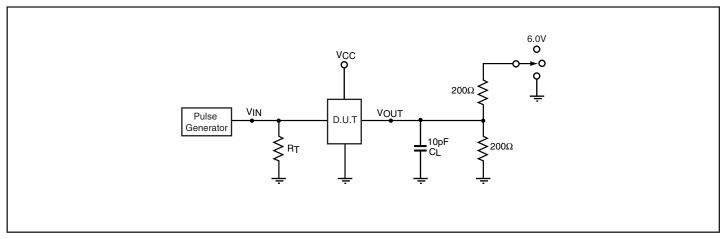
#### **Notes:**

- 1. See test circuit and waveforms.
- 2. This parameter is guaranteed but not tested on Propagation Delays.
- 3. The switch contributes no propagational delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25ns for 10pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagational delay to the system. Propagational delay of the switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

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### **Test Circuit for Electrical Characteristics**



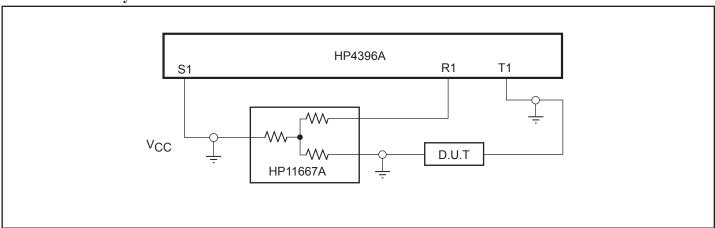
#### **Notes:**

- C<sub>L</sub> = Load capacitance: includes jig and probe capacitance.
- $R_T$  = Termination resistance: should be equal to  $Z_{OUT}$  of the Pulse Generator
- All input impulses are supplied by generators having the following characteristics:  $PRR \le 10 \text{ MHz}$ ,  $Z_O = 50\Omega$ ,  $t_R \le 2.5 \text{ns}$ ,  $t_F \le 2.5 \text{ns}$ .
- The outputs are measured one at a time with one transition per measurement.

#### **Switch Positions**

Test	Switch
t <sub>PLZ</sub> , t <sub>PZL</sub>	6.0V
t <sub>PHZ</sub> , t <sub>PZH</sub>	GND
Prop Delay	Open

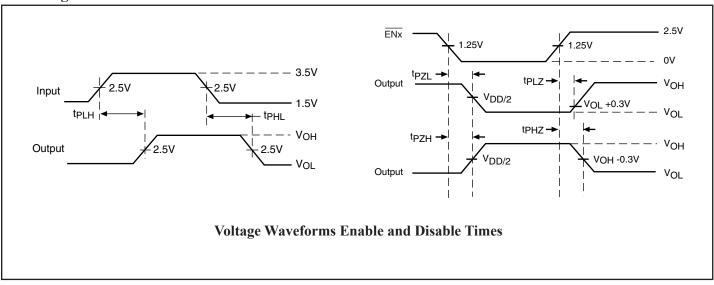
## **Test Circuit for Dynamic Electrical Characteristics**



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## **Switching Waveforms**



### **Applications Information**

# **Logic Inputs**

The logic control inputs can be driven upto 3.6V regardless of the supply voltage. For example, given a +3.3V supply,  $\overline{\text{EN}}$  may be driven LOW to 0V and HIGH to 3.6V. Driving  $\overline{\text{EN}}$  Rail-to-Rail<sup>®</sup> minimizes power consumption.

#### **Power Supply-Sequencing**

Proper power supply sequencing is recommended for all CMOS devices. Always apply V<sub>CC</sub> before applying signals to the input/output or control pins.

#### **Hot Insertion**

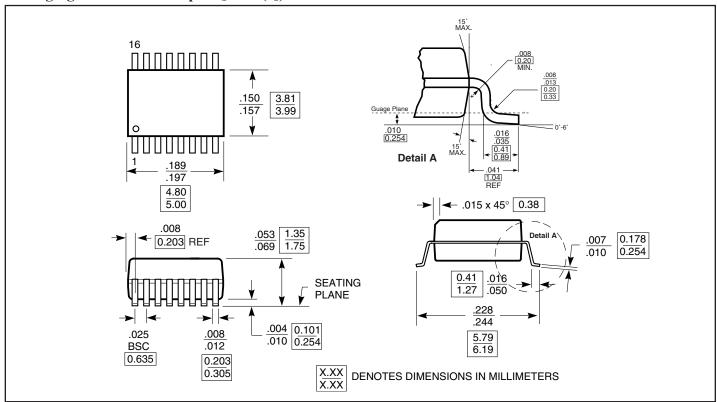
For Datacom and Telecom applications that have ten or more volts passing through the backplane, a high voltage from the power supply may be seen at the device input pins during hot insertion. The PI3CHxx devices have maximum limits of 6V and 120mA for 20ns. If the power is higher or applied for a longer time or repeatedly reaches the maximum limits, the devices can be damaged.

Rail-to-Rail is a registered trademark of Nippon Motorola, Ltd.

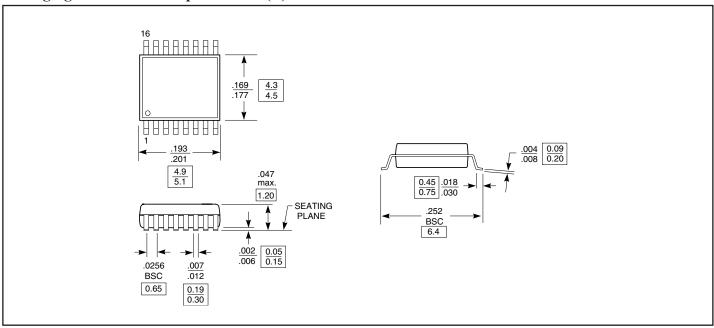
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## Packaging Mechanical: 16-pin QSOP (Q)



## Packaging Mechanical: 16-pin TSSOP (L)





# **Ordering Information**

Ordering Code	Packaging Code	Package Description
PI3CH400L	L	170-mil, 16-pin TSSOP
PI3CH400LE	L	Pb-free & Green, 170-mil, 16-pin TSSOP
PI3CH400Q	Q	150-mil, 16-pin QSOP
PI3CH400QE	Q	Pb-free & Green, 150-mil, 16-pin QSOP

#### **Notes:**

- Thermal characteristics can be found on the company web site at www.pericom.com/packaging/
- E = Pb-free & Green
- Adding an X suffix = Tape/Reel